



Product Change Notification

Change Notification #: 116160 - 00
Change Title: Intel® Server Chassis H2204XXLRE,
PCN 116160-00, Product Design,
Tool less HDD carrier
Date of Publication: March 14, 2018

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: *	March 29, 2018
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Server Chassis H2204XXLRE.

1. The HDD carrier does not require screws to hold the drive. The latch button has a new design.

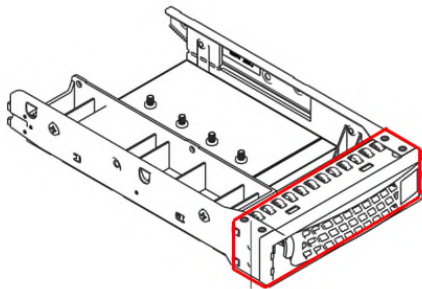


Image 1. Latch handle before change

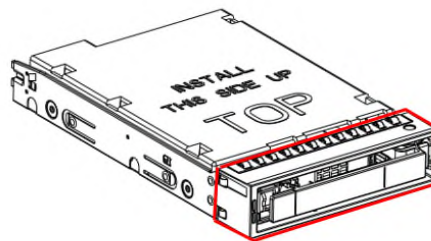


Image 2. Latch handle after change

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
H2204XXLRE	957322	J32925-005	J32925-006

PCN Revision History:

Date of Revision:

March 14, 2018

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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